

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
77	BRS	308	printed adj circuit adj board adj design	USPAT	2003/07/03 11:20		
98	BRS	2291	die same packaging and interconnect	USPAT; US-PGPUB; DERWENT	2003/07/10 10:20		
99	BRS	1927	die same packaging and interconnect and substrate	USPAT; US-PGPUB; DERWENT	2003/07/10 10:20		
100	BRS	456	die same packaging and interconnect and substrate and routing	USPAT; US-PGPUB; DERWENT	2003/07/10 10:36		
101	BRS	82	die same placement same interconnect and routing	USPAT; US-PGPUB; DERWENT	2003/07/10 10:46		
102	BRS	70	die same placement same interconnect and angle	USPAT; US-PGPUB; DERWENT	2003/07/12 10:19		
103	BRS	159	rats same nest	USPAT; US-PGPUB; DERWENT	2003/07/12 10:20		
104	BRS	12	(rats same nest) and integrated adj circuit	USPAT; US-PGPUB; DERWENT	2003/07/12 10:23		
105	BRS	1	(rats same nest) and integrated adj circuit and die	USPAT; US-PGPUB; DERWENT	2003/07/12 10:23		
106	BRS	5033	interconnect same die	USPAT; US-PGPUB; DERWENT	2003/07/12 10:24		
107	BRS	1709	interconnect same die and integrated adj circuit and packaging	USPAT; US-PGPUB; DERWENT	2003/07/12 10:24		
108	BRS	1455	interconnect same die and integrated adj circuit and packaging and substrate	USPAT; US-PGPUB; DERWENT	2003/07/12 10:24		
109	BRS	619	interconnect same die same integrated adj circuit and packaging and substrate	USPAT; US-PGPUB; DERWENT	2003/07/12 10:25		
110	BRS	244	interconnect same die same integrated adj circuit and packaging and routing	USPAT; US-PGPUB; DERWENT	2003/07/12 10:25		
111	BRS	70	interconnect same die same integrated adj circuit and packaging and routing and angle and substrate	USPAT; US-PGPUB; DERWENT	2003/07/12 10:53		
112	BRS	18	interconnect same die same integrated adj circuit and packaging and routing and netlist	USPAT; US-PGPUB; DERWENT	2003/07/12 10:55		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
113	BRS	57	routing same die same integrated adj circuit and netlist	USPAT; US-PGPUB; DERWENT	2003/07/12 13:36		
130	BRS	239	multi-chip and package and placement and dies	USPAT; US-PGPUB	2003/07/13 13:52		
131	BRS	615	multi-chip and package and placement and die	USPAT; US-PGPUB	2003/07/13 13:52		
132	BRS	217	multi-chip and package and placement and die and angle	USPAT; US-PGPUB	2003/07/13 13:52		
133	BRS	96	multi-chip and package and placement and die and angle and routing	USPAT; US-PGPUB	2003/07/13 14:09		
134	BRS	0	multi-chip and package and placement and die and angle and routing	DERWENT	2003/07/13 14:09		
135	BRS	1112	engineering same change same order	USPAT; US-PGPUB; DERWENT	2003/07/13 14:10		